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Ultraviolet Optical Excitation of Near Infrared Emission of Ybdoped Crystalline Aluminum Oxynitride Thin Films

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Abstract

Yb³⁺ ions hold promises for high power emission in the near infrared (NIR). Yet, relevant matrices, comprising mediators to excite Yb^{3+} , have to be found and the optical mechanisms to be studied in details. This is the purpose of this study that reports on the optical excitation and emission mechanisms of NIRphotoluminescence (PL) of Yb-doped crystalline aluminum oxynitride thin films prepared at room temperature using reactive magnetron sputtering. Crystal structure and chemical composition are analyzed by transmission electron microscope (TEM) and Rutherford backscattering spectrometry (RBS), respectively. Photoluminescence spectroscopies are used to investigate the excitation and emission mechanisms. NIR emission at 985 nm is obtained under indirect optical excitation using the 325 nm line of an He-Cd laser, the excitation mechanism is explored by photoluminescence excitation measurement (PLE) and the fine structure of the emitted energy levels is investigated by performing PL measurements at low temperature (LTPL). PLE shows that the host defects play the role of mediators to transfer the excitation energy to Yb ions. This offers different possibilities for the development of multiple excitation channels for Yb³⁺. Stark splitting of the energy levels of the ${}^{2}F_{5/2}$ and ${}^{2}F_{7/2}$ transitions is evidenced using LTPL in the 78 to 295 K range.Electronic transitions are ascribed to experimental emission lines based ongood agreement with theoretical values. Moreover, the activation energies for PL thermal quenching are determined and correspond to the energy difference between highest energy quenched lines and thermally activated "hot lines".

Introduction

Luminescence properties of rare earth-doped wide bandgap materials attract attention due to the development of UV and visible light emitting devices.¹⁻³A large bandgap offers high luminescence efficiency and favorable optical properties. III-V semiconductors meet this criterium and exhibit excellent integration with silicon technology.¹ Thus, many works were directed to the investigation of the optical properties of RE-doped III-V compounds,⁴⁻⁷ with particular attentions to RE-doped III-nitrides.⁸⁻¹⁰ III-nitrides e.g. (Al, In, Ga)N demonstrated efficient optical activations for a number of RE ions.¹¹AlN exhibits specific physical/chemical properties such as high thermal conductivity,¹²⁻¹³ Excellent piezoelectric coefficient d_{33} ,¹⁴⁻¹⁶ thermal¹⁷ and chemical stabilities.¹⁸Hence, it is well suited for applications in spintronic,¹⁹ surface acoustic wave²⁰ and optoelectronic devices.²¹The optical activities of several lanthanide elements incorporated in AlN, covering the light spectrum from UV (Gd),²² blue (Ce, Eu, Tm),²³⁻²⁴ green (Tb),²⁵ yellow (Dy),²⁶red (Sm, Eu)²⁶ to IR (Nd),²⁷⁻²⁸ have been investigated.Yet, Yb has been little considereddespite it holds some advantages.Yb³⁺is characterized by a relatively simple electronic configuration compared to other RE^{3+} . It is considered as two energy levels system consisting f two energy terms ${}^{2}F_{5/2}$ and ${}^{2}F_{7/2}$. Thanks to this electronic simplicity. Yb^{3+} placed in different host matrices constitutes a good platform to extract useful information about f-f transitions in RE³⁺. Hence, it stimulates extensive investigations, in particular on theoretical calculations. In addition, the energy separation between the ground and excited states of Yb^{3+} equals ~ 1.23 eV and related transitions emit photons in the NIR (~1000 nm). This makes Yb^{3+} competitive with the well-known, widely used in solid state lightening devices, Nd³⁺ ion that emits in the same region. Although Nd³⁺ is widely used, Yb³⁺the simpler energy level structure of Yb³⁺minimizes the undesirable cross relaxation, the up-conversion and excited-state absorption processes that lead to luminescence quenching in Nd-based systems.²⁹ Hence, higher output powers could be obtained by reaching higher concentration of Yb than Nd before quenching occurs. In addition, the longer lifetime of the upper excited state of Yb³⁺ compared to other RE³⁺ ions provides a better storage of the pump energy, which is desirable in laser applications. However, in contrast with Nd³⁺ that exhibits several excited states and allows different pumping possibilities, $^{30-31}$ the simple $^{2}F_{5/2}$ and ²F_{7/2}structure limits the direct optical excitation of Yb³⁺to the related transitions lying in the 920-1050 nm region.³²⁻³³Therefore, for better exploiting the optical advantages of Yb^{3+} , it is important to search for new pumping schemes. Hence, much efforts have been spent to find an indirect, more efficient, way to excite Yb^{3+} by energy transfer via another ion such as Ce,

Nd.....etc.³⁴⁻³⁷In this line, this report deals with the indirect optical excitation of Yb³⁺ ions using AlN defects as mediators for the energy transfer mechanism. This approach avoids the complexity associated to the use of another ion for the energy transfer process to Yb³⁺. So far, Yb hasn't been given enough attention as optically active ion in *crystalline* AlN.²⁸ Zanatta, A.R. et al,^{26,38} have screened the effect of thermal annealing on the optical absorption and emission signals of amorphous/nanocrystalline AlN thin films considering Yb among other RE ions, whereas Koubaa, T., et al²⁸ theoretically studied the spectral and energy levels of Yb in crystalline AlN thin films based on cathodluminescence measurements. A dedicated comprehensive study of the optical excitation and emission mechanisms of Yb in crystalline AlN is still needed, which is the purpose of this report on a systematic study ofYb-doped crystalline AlN thin films in which oxygen incorporation is shown to play a strong role.

Experimental section

Yb-doped Al(O)N thin films were deposited using RF (Dressler, CESAR RF power generator) balanced reactive magnetron sputtering. A high vacuum pressure of 1×10⁻⁶ Pa was obtained by using a turbo molecular pump (BOC EDWARDS EXT 255HI) coupled to a mechanical primary pump. A modified aluminum disk (99.99% purity, neyco vacuum & materials) of 2 inch diameter was used that incorporates a thin bar of metallic Yb(99.9% purity) with differentrelative Yb/Al surface areas in order to obtain different Yb concentrations in the deposited films. Constant gas composition of Ar and nitrogen with 65% nitrogen was controlled by adjusting the argon and nitrogen gas flow rates and keeping the total pressure (0.7mtorr) constant using an MKS mass flow controller. A flow rate of oxygen was applied using *all-metal gas regulating valveallowingfine control of the oxygen partial* pressure before deposition to be 0.1x 10⁻⁶torr. The partial pressure of oxygen has been measured using in situ mass spectrometry. This led to ~7 at.% of oxygen in the samples. The compositional analysis wasperformed by Rutherford backscattering spectrometry (RBS) with a 2 MeV He⁺ beam. The experiments were performed with the 5MV accelerator available at Centro de Microanálisis de Materiales (CMAM) from Universidad Autónoma de Madrid (Madrid, Spain).Due to the lowdetection resolution of RBS for the low content of light elements as well as the overlapping of O and N regions, the oxygen concentrations~ 6-7 at.% was quantified using calibrated EDS coupled to a transmission electron microscope.Silicon (100) substrates have been ultrasonically cleaned in ethanol and fixed at 5 cm distance from the Al target, facing the target axis. The deposition time was adjusted to reach a thickness close to 200 nm as monitored using in-situ by laser interferential reflectometry. More details about this method and deposition chamber schematic can be found in ref.³⁹The samples underwent a*post*-deposition rapid thermal annealing (RTA) at 1000 °C in forming gas (FG) ($N_2/H_2 \% = 90/10$) for 5 minutes. The microstructure was investigated by transmission electron microscopy (TEM) in a JEOL ARM 200-Cold equipped with a field-emission gun (FEG) fitted with a GIF Quantum ER.Steady state PL experiments were performed at room and lowtemperatures. Forlow temperature PL measurements (LTPL), the sample of 1 at.% of Ybwas pasted onto the holder attached to a cold-finger in an opened-cycle N₂-cryostat. The sample can be cooleddown to 77 K and the temperature was controlled by a heat controller by successive steps till 298 K. The cryostat was pumped down to 1×10^{-3} torr.Samples were excited by the 325 nm line of He–Cd laser. For PLE spectroscopy, samples were excited by a xenon arc lamp source. PL emission was analyzed by a cooled silicon-based CCD camera.

Results and discussion

Compositionand microstructure

Four thin films of Yb-doped Al(O)N with different Yb concentrations have been prepared. The composition analyses have been performed using RBS spectrometry to probe the Yb, Al, N, O elements content. Figure (1) shows the RBS spectrum performed with a 2 MeV He⁺ beam using a 5MV accelerator. In the RBS spectrum, the regions corresponding to the different elements are labeled (Yb, Al, Si, O, N). The content of each element is indicated in the inset table. The composition analysis shows a clear variation in Yb concentration (0.05, 0.5, 1, and 1.5 at.%)with experimental conditions, N/Al ratio in the 0.91 – 1.03 range and incorporation of ~ 7% of oxygen in all samples.Chemical analyses were also performed using energy dispersive spectroscopy of X-rays embedded in the TEM and reproduce the evolution obtained using RBS (not shown). For investigating the microstructure,TEM measurements have been performed andwe did not find significant changes in the microstructure upon increasing the Yb content. Figure (2) shows the TEM and corresponding SAED of a selected sample containing 1% of Yb. The film exhibits columnar structure and the partial electron diffraction rings with localized bright spots is consistent with the polycrystalline nature of this sample with preferred orientation along [002].

Room temperature Photoluminescence spectroscopy

The photoluminescence response of the prepared samples was measured under excitation by 325 nm. Figure (3a) shows the PL signal of the as-deposited samples of different Yb contents. PL spectra can be divided into two main regions: broad bands in the visible region (~ 450-600 nm) and sharper bands in the NIR (~ 900-1050 nm). The bands in visible region are attributed to radiative defects in the AlN matrixas reported for undoped AlN.⁴⁰No PL signal related to Yb³⁺ ions have been previously reported in this region. The NIR emission bands are characteristic of Yb³⁺ions, usually encountered around (967-1030 nm), as reported elsewhere^{28,41} and are assigned to the optical transitions from ${}^{2}F_{5/2}$ to ${}^{2}F_{7/2}$.⁴²⁻⁴³ It is well established that thermal annealing is required to enhance the emission from RE ions in AlN.³⁸ Thus, all samples underwent thermal activation process via rapid thermal annealing (RTA) in forming gas (FG) at 1000 °C/5 min. Then the PL of the annealed samples (RTA) were measured using the same excitation wavelength. Figure (3b) shows the PL spectra of RTA samples. It is found that the PL intensity is thereby increased by a factor of 20 or more, depending on the Yb content. Moreover, the spectral shape is modified. In the as-deposited samples, the visible and NIR bands exhibit symmetrical non-splitting PL shapewith peaks centered around 500 nm and 987; respectively. In annealed samples, they display asymmetrical splitting intense PL bands centered around 450 nm and 985 nm. Increasein theoptical emission intensity of RE triggered annealing is a common behavior correlated with the reduction of non-radiative pathways as thermal annealing may locally rearrangement the structure favoring the development of a less disordered AlN matrix.³⁸The evolution PL intensity from annealed samples with the Yb content is shown in inset Fig. (3b). The optimum concentration for highest PL intensity is found around 1 at.%. At relatively low concentration of Yb, the PL intensity increases as the number of emitting ions increase till it reaches a critical concentrationat which nonradiative energy transfer between neighboring RE ions becomes significant.²⁵In addition, increasing the RE contentin AlN leads to degradation in the quality of the matrix, as demonstrated in [40] for Ce-Al(O)N.

Low temperature Photoluminescence and PL quenching mechanism

Regarding the spectral shape, it is found that the NIR emission of 1% Yb-Al(O)N_RTA sample, compared to the as-deposited state, consists mainly of well resolved peak located at 985 nm, a shoulder at 970 nm, a small peak at 994 nm with other small humps observed at 1000, 1007, and 1020 nm, as shown in Fig. (4).In addition, a broad background at the base of the emission spectrum can be observed, which is likely due to overlapping between unresolved spectral lines.In order to better resolve the energy sub-levels in the PL signal, low

temperature PL (LTPL) was carried out. Figure (5a) shows the PL spectra for Yb-doped Al(O)N sample excited by 325 nm and measured from 78 k to 295 K. For better contrasting the modifications, the PL spectra for 78 K and 295 K are plotted together, see Fig. (5b).While temperature little affects the shape of the visible bands, NIR peaks are much better resolved at low temperature. All lines and bands show increase in intensity from 295 K down to 78 K except the small bands indicated by the black square **I**, as shown in fig (5b). The PL intensity of these two bands is thermally activated (populated), unlike other lines/bands that are thermally quenched.

It is well established that the energy levels of RE ions undergo spectral splitting into "Stark levels" due to coulomb, spin orbital, and crystal field interactions. However the crystal field plays the most significant contribution in this regard, particularly in RE-doped crystalline materials. Upon RE³⁺ incorporation into crystalline Al(O)N the energy states of $4f^n$ electrons experience a disturbance due to the applied crystal electric field. The influence of this crystal field on the energy levels of the REs ions can be probed by low temperature PL measurements due to the reduction of the thermal motion of the carriers. The strength and number of the splitting levels is depending on the strength of the local crystal field and on the crystal symmetry around the lattice location of the RE³⁺; respectively. This is the physical reason behind the observed spectral splitting in many RE³⁺ ions such as Pr³⁺,⁴⁴ Sm³⁺,⁴⁵Tm³⁺,⁴⁶and Nd³⁺.⁴⁷ It is also relevant for Yb³⁺ in GaN.^{10,41,48} However, to the best of our knowledge, there is only one report dealing with theoretical calculation of Yb in crystalline AlN based on crystal field theory and supported by cathodoluminescence (CL) data.²⁸Up to 25 emission lines/shoulders/humps were found andthe authors couldn't explain such complicated CL spectrum by assuming only Yb³⁺substituting the Al site (Yb_{Al}), and hadto consider a formation of (V_N-Yb) defect complex in their calculation.

The careful examination of the PL at 78k reveals only 9 transitions, as shown in Fig. (6a), suggesting that Yb³⁺ions are located on a single site, Yb_{Al} in our samples. The two spin orbit manifolds ${}^{2}F_{7/2}$ and ${}^{2}F_{5/2}$ are split into at most (2j+1)/2 sublevels, resulting in four and three crystal field levels (doublets), respectively.⁹At least four PL transitions are, therefore, expected if these transitions are considered only from the lowest excited level in ${}^{2}F_{5/2}$, and twelve if transitions from other sublevels are also considered, see the schematic diagram of the energy levels in Fig. (6b) and their corresponding values reported in 28 for Yb ions substitute the Al-site(Yb_{Al}) in AlN matrix.All the measured PLlinescorrespond to the theoretical calculation with small shifts, except the two small transitions at 1049 nm and 1080

nm (correspond to peak 8 and 9in fig. (6a); respectively) that might be related to a different location(s) of Yb, but with a small density of such states based on the very low intensity of related emissions.²⁸ The slight shift between the calculated and measured values can be attributed to the difference in crystal field strength between the two studies. It is well established that the local site symmetry, the crystal field strength, and the ligand arrangements significantly modify the energy level values and the transition probabilities from the sublevels.⁴⁶ These parameters are mostly related to the matrix properties for Yb in different materials as well as in the same material by local structural modifications. Hence, when the local environment around Ybis changed, the strength and the excitation cross section as well as the branching ratio of the transition lines is altered.⁴⁶ Our results reveal that a good control over the growth conditions and subsequent annealing is essential to adjust the positioning of Yb ions in Al(O)N as well as for activating the emission properties.

Looking at the thermal dependence of emission intensities, two opposite behaviors are found in Fig. (7). Transition bands indicated by black squares • (one in visible and one in NIR regions) are thermally activated (populated), unlike all other observed transitions, which are thermally quenched (de-populated), fig (5b). The thermal evolution of NIR band **•** and summed integrated intensities for all thermally quenched lines (transitions 2 to 9) are shown in Fig. (7 a). The integrated signal for lines 2 to 9 shows thermal quenching by about 23% while the NIR band shows PL enhancement by 30% with temperature increasing up to 295K. It is widely established, as described above, that the excitation of 4f-4f transitions in RE is achieved by energy transfer via a mediator. This mediator can be the host material(e.g. point defects), as in our case, or another ion (e.g. RE or transition metal). PL thermal quenching pathways can be generally proposed through two channels:⁴⁹⁻⁵⁰In the first channel, with increasing the temperature the gained thermal energy is partially absorbed by the excited mediator and leads to dissociation of its carrier before it transfers the excitation energy to the core localized f-f levels of the RE. In this case, the characteristic time of the quenching process should be shorter than the time of energy transfer to the f-f levels. In the second channel, the gained thermal energy is partially absorbed by the generated carriers in the f-flevels and leads to dissociation of these carriers before it recombines. The later can occur by back energy transfer to the mediator or to another defect that subsequently loses the energy either by radiative or nonradiative processes. This requires that the back energy transfer process is faster than f-f recombination process. It is worth mentioning that, any energy mismatch in the energy transfer process can be accommodated by phonon assistance.⁴⁹⁻⁵⁰

For understanding the quenching mechanism, the quantitative analysis of the PL thermal quenching evolution with temperature is performed using the Arrhenius equation, see equation (1). The thermal dependence of the PL intensity can be generally described by the Arrhenius equation (1)using the single⁵¹ or double exponential terms⁵²⁻⁵³:

$$I(T) = \frac{I_0}{1 + c_1 Exp\left(-\frac{E_{A1}}{K_B T}\right) + c_2 Exp\left(-\frac{E_{A2}}{K_B T}\right)},\tag{1}$$

where I(T) is the PL intensity at the temperature of T, I_0 is the integrated PL intensity at 78 K, E_{A1} and E_{A2} are the activation energies, c_1 and c_2 are fitting constants and k_B is Boltzmann's constant. Therefore, the exponential decay behavior of $(\frac{I_0}{I} - 1)$ versus T⁻¹ can be used as aguide for the Arrhenius fitting.

Figure (7 b) shows the data along with the best fit to the Arrhenius plot of integrated PL intensity for thermally de-populated peaks 2 to 9. From the fitting, two activation energies can be estimated, E_{a1} = 11.1 meV and E_{a2} = 1200 meV. In order to understand the physical meaning behind the two activation energies, the approach proposed in⁵² can be used. The authors noticed that the thermal quenching in the PL lines of Er in GaN is accompanied with thermal activation (population) of other lines called "hot lines". In addition, they found that the estimated activation energy is very close to the energy mismatch (energy displaced) between hot and quenched lines. Following the same approach in our case, it is found that the energy displaced between the transition of highest energy within the quenched lines, peak 2 at 981.7 nm (1262 meV), and the thermally activated lines (■) at 972.2 nm (1274.6 meV) and 500 nm (2479 eV) equals 12.2 and 1217 meV, respectively. It is very consistent with the estimated activation energies Ea1 and Ea2, respectively. This infers that the thermal quenching of Yb³⁺NIR emission in our samples occurs via energy transfer to thermally populated levels (**■**) emitting at 500 nm and 972.2 nm. Hence, it can be considered that part of the population of these two levels (**■**) is enhanced by phonon-assisted energy transfer from the quenched PL lines in NIR region.

Photoluminescence excitation (PLE) and excitation mechanisms

Understanding the origin of this NIR emission requires information about the excitation mechanism of Yb^{3+} . In our case, intense NIR emission from Yb^{3+} is obtained by 325 nm excitation despite, as mentioned, Yb^{3+} has no known absorption band in the UV-Visible regions. This evidences an efficient indirect excitation from the host to Yb^{3+} ions. Moreover, as the 325 nm is fairly below the bandgap energy of AlN (~210 nm), this confirms that the energy transfer from AlN to Yb^{3+} is mediated by matrix defects located in the bandgap.

In order to probe the excitation mechanisms, PLE measurements have been carried out by monitoring the PL peak at 985 nm.Figure (8) shows the detected PLE spectrum which exhibits two bands located at photon energies (~ 3.9 and 4.8 eV). It is worth to mention that the positions of these bands are very close to the PLE bands positions of Ce-doped Al(O)N reported in our previous work.⁵⁴Hence, the assignment for the PLE bands in Yb-doped Al(O)N can be done to the light of the previous assignment of the PLE of Ce-doped Al(O)N samples. Based on that, these bands can be ascribed to the host defects, more precisely to defect complexes involving Al-vacancy with oxygensubstituting nitrogen.However, in the present PLE, the band around 3.9 eV exhibits much lower relative intensity than the band at 5 eV while in the case ofCe-doped Al(O)N,the twobands have comparable intensities. The higher intensity of the 3.9 eV band in Ce case explained by the overlapping between the Ce³⁺ and (V_{Al}-O_N) defect complex absorption bands.

From electronic structure point of view, Berzina, et al⁵⁵reported on the origin of the luminescence from AlN involving two types of defects associated with oxygen; V_{Al}-O_N defect complexes and separate O_N defect. The authors proposed excitation and emission mechanisms based on exciting V_{Al}-O_N defect (located at around 1.2 eV above the valence band) to its excited state, probably situated close to the conduction band. This isfollowed by electron transfer to a separate O_N defect located around 4.3 eV above the valence band of AlN. UV/Visible emission (~ 3.1 eV ≈ 400 nm) can be subsequently be detected due to a radiative transition from the separate O_N defect to V_{Al}-O_N defect complex.⁵⁶ In the same direction Shi, S.-C., et al⁵⁶ based on PLE measurements reported on a possible additional excitation pathway from V_{Al}-O_N defect complex level to the separateO_N which is probably responsible for absorption at 3.4 eV and emission around 3.2 eV. Moreover, Yan, Q., et al.⁵⁷ precisely separated the V_{Al}-O_N defect complexes into two types of complexes (V_{Al}-O_N)²⁻ and (V_{Al}-2O_N)¹-depending on the oxygen concentration that give rise to an absorption around 3.9 eV

due to electronic transitions $[(V_{Al}-O_N)^{2-} \Rightarrow (V_{Al}-O_N)^{1-} + e)]$ and 4.7 eV due to electronic transitions $[(V_{Al}-2O_N)^{1-} \Rightarrow (V_{Al}-2O_N)^0 + e].$

Thus, from the above, three possible excitations routes based on V_{AI} -O_N defect complexes can be summarized, see the schematic diagram Fig. (9). The first (I) from V_{AI} -O_N level to its excitation state near to the band gap,which represents the electronic transitions $[(V_{AI}-2O_N)^{1-}$ $=> (V_{AI}-2O_N)^{0+}$ e] with absorption energy of 4.7 eV. The Second (II)from V_{AI} -O_N level to its excitation state due to electronic transitions $[(V_{AI}-O_N)^{2^-} => (V_{AI}-O_N)^{1^-}$ e)] with absorption energy of 3.9 eV. The Third (III) from V_{AI} -O_N level to separate O_N level with absorption of 3.4 eV photons. This shows the important role that can be played by V_{AI} -O_N defect complexes in the optical behavior of Al(O)N matrix. This role has beenexploited to open indirect efficient excitation pathway to Mn²⁺-doped AlN for red light emission phosphors as reported in⁵⁸and more recently in our work with Ce-doped AlN for blue light emission phosphors.⁵⁴In the same line, as 325 nm (~3.81 eV) is used in the present study, the second excitation route is likely consistent with this absorption energy. Thus, the V_{AI} -O_N defect complexes act as donoracceptor pairsexcited by 325 nm light to its excited level (V_{AI} -O_N)¹⁻.^{22,57}After relaxation, part of the absorbed energycan be emitted in the UV/Visible region⁵⁹and part can be efficiently transferred to Yb³⁺ ions emitting around 985 nm upon relaxation.

Conclusion

Crystalline Yb-doped Al(O)N thin filmshavebeen prepared with different Ybcontentsmeasured using RBS. The crystal and the microstructure have been analyzed by XRD and TEM techniques.NIR emission at 985 nm was obtained from the prepared samples under indirect excitation by 325 nm wavelength. The NIR emission is assigned to the typical ${}^{2}F_{5/2}$ and ${}^{2}F_{7/2}$ transitions in Yb³⁺ ions. The optimum Yb concentration giving highest PL intensity is determined to be 1 at.%. Post-deposition annealing is essential to improve the emission intensity. The indirect excitation of Yb ions is proposed to proceedthrough host defects as evidenced by PLE. The fine structure of the Yb energy levels has been obtained using low temperature PL measurements and the different contributions of this fine structure arein good agreement with theoretical calculation for Yb_{Al} in AlN.In addition, quantitative analysis of the thermal dependency of emission intensity is in good agreement with quenching via back energy transfer to thermal populated levels. This dedicated study providesnew details about the optical behavior of Yb in aluminum-based oxynitride materials and proposes a way to indirectly excite Yb ions without the need of a RE mediator. This could serve as a platform

for the development of future solidstate lighting devices and better engineering of Yb emission in NIR region.

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Figure captions

Figure 1: RBS fitting data for the prepared Yb-doped Al(O)N samples at different Yb%. Inset table is the elemental quantitative values.

Figure 2: a) TEM image and b) the corresponding SAED pattern of 1% Yb-doped Al(O)N thin film.

Figure 3: PL spectra of Yb-doped Al(O)N of different Yb% for a) as-deposited and b) annealed samples . Inset in b): PL intensity of the NIR fundamental peak at 985 nm as a function of Yb%.

Figure 4: Zoom in NIR PL spectra of as-deposited and annealed 1% Yb-doped Al(O)N samples.

Figure 5: a)PL spectra of 1% Yb-doped Al(O)N film for different temperatures from 78K to 295K. b) is the PL of 1% Yb-doped Al(O)N sample carried out at 78K and 295K. The excitation wavelength is 325 nm.

Figure 6: a) Zoom in for the NIR emission carried out at 78K. b) Calculated energy levels diagram for Yb^{3+} ions in Al substitutional site (Yb_{Al}) in AlN (on left). The theoretical (Theo.) and experimental (Exp.) transition lines positions (table on right).

Figure 7: a) Normalized PL as a function of temperature for band number 1 and integrated intensity for lines from 2 to 9 in fig (10 a). b) $\left(\frac{I_0}{I(T)} - 1\right)$ versus T⁻¹ for Arrhenius guiding of 1% Yb-doped Al(O)N sample.

Figure 8: PLE spectrum of annealed 1% Yb-doped Al(O)N samples compared with the PLE of annealed 1% Ce-doped Al(O)N (reported in ref.⁵⁴) monitored at emission wavelengths 985 nm and 500 nm; respectively.

Figure 9: Schematic diagram representing the proposed excitation and emission processes of Yb in Al(O)N host. I, II and III are the excitation routes at excitation energies 4.7 eV, 3.9 eV, and 3.4 eV; respectively.

















Figure 5





Figure 6



Table I: Calculated transitions and measured PL lines (in	
nm) for Yb ³⁺ ions in Al substitutional sites Yb _{Al} .	



Transition label	Calculated transition, ^[28]	Measured PL positions in the present study (peak no.)
А	974	972.2 (1)
В	1002.9	999.8 <mark>(5)</mark>
С	1013	
D	1023.23	1019.7 (7)
E	967	
F	995.2	996.6 <mark>(4)</mark>
G	1005.22	1007 (6)
н	1013	
1	943.9	
J	970	972.2 (1)
к	979	981.7 <mark>(2)</mark>
L	989	987.7 <mark>(3)</mark>

Figure 7





Figure 8



Figure 9



Al(O)N